

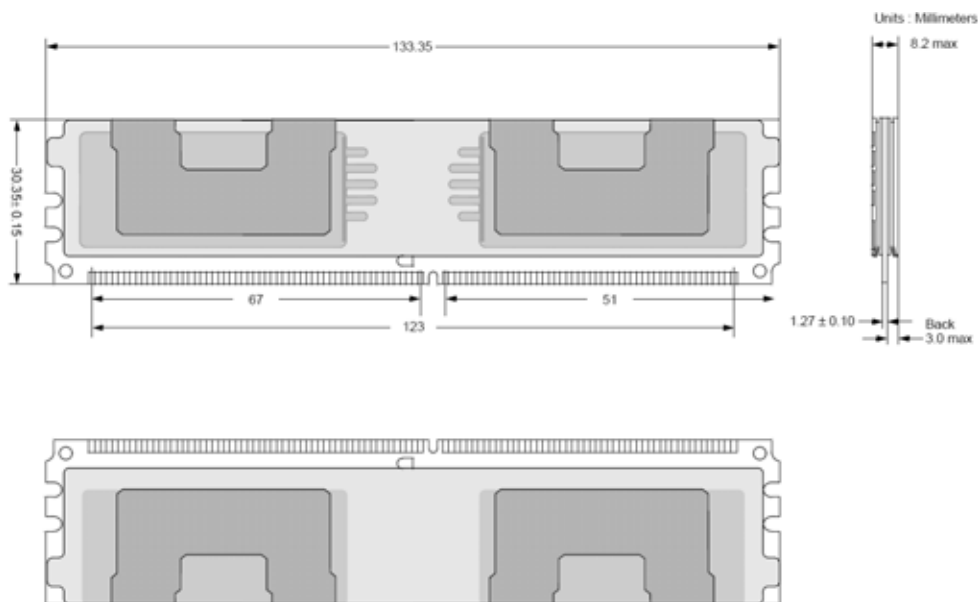
Products in Family

GRST6340LV/4GB (2 x 2GB Low-Voltage 2R DIMMs)
GRST6340LV/8GB (2 x 4GB Low-Voltage 2R DIMMs)
GRST6340LV/16GB (2 x 8GB Low Voltage 2R DIMMs)



| Features | Description |
|---|---|
| 240-pin JEDEC-compliant DIMMs 133.35 mm wide by 30.35 mm high (1.195" x 5.25") Data Transfer Rate: 5.3 Gigabytes/sec Operating Voltage (Nominal): VDD = 1.5 V; VCC = 1.5V Full DIMM Heat Spreader Fully RoHS Compliant | Each GRST6340LV upgrade consists of a matched set of two DDR2-667 Low-Voltage (1.5V) FB-DIMMs. One Advanced Memory Buffer (AMB) is used as the interface between the system memory bus and DIMM DRAMs. One 2K-bit EEPROM is used for Serial Presence Detect. For improved thermal performance, a Full DIMM Heat Spreader with thermal interface material (TIM) is attached to the front and back of the DIMM. |

| Dataram Product | Sun Microsystems Product | Supported in these Sun Microsystems systems: |
|---|--|--|
| GRST6340LV/4GB GRST6340LV/8GB GRST6340LV/16GB | T6340-X-22 T6340-X-24 T6340-X-28 | Sun SPARC T6340 Server Module |



Notes

Tolerances on all dimensions except where otherwise indicated are ± 0.13 (.005).

All dimensions are expressed in millimeters